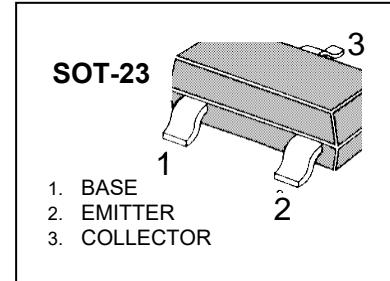


BFR93 PNP Silicon RF Transistor

FEATURES

- For low distortion broadband amplifiers up to 1 GHz at collector currents from 2mA up to 20mA



Marking X1s

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$)

Rating	Symbol	Value	Unit
Collector – Emitter Voltage	V_{CEO}	12	V
Collector – Base Voltage	V_{CBO}	15	V
Emitter – Base Voltage	V_{EBO}	2	V
Collector Current	I_C	35	mA
Power Dissipation	P_{tot}	300	mW
Junction Temperature	T_{JMAX}	150	°C
Operating Junction Temperature Range	T_J	-65 to +150	°C
Storage Temperature Range	T_{STG}	-65 to +150	°C

Thermal Resistance

Junction - soldering point 1)	R_{thJS}	≤ 305	K/W
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1) T_S is measured on the collector lead at the soldering point to the pcb.

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

DC Characteristics

Collector-emitter breakdown voltage $I_C = 1 \text{ mA}, I_B = 0$	$V_{(BR)CEO}$	12	-	-	V
Collector-base cutoff current $V_{CB} = 5 \text{ V}, I_E = 0$	I_{CBO}	-	-	50	nA
Emitter-base cutoff current $V_{EB} = 2 \text{ V}, I_C = 0$	I_{EBO}	-	-	10	μA
DC current gain $I_C = 30 \text{ mA}, V_{CE} = 8 \text{ V}$	h_{FE}	20	60	-	-

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

AC Characteristics

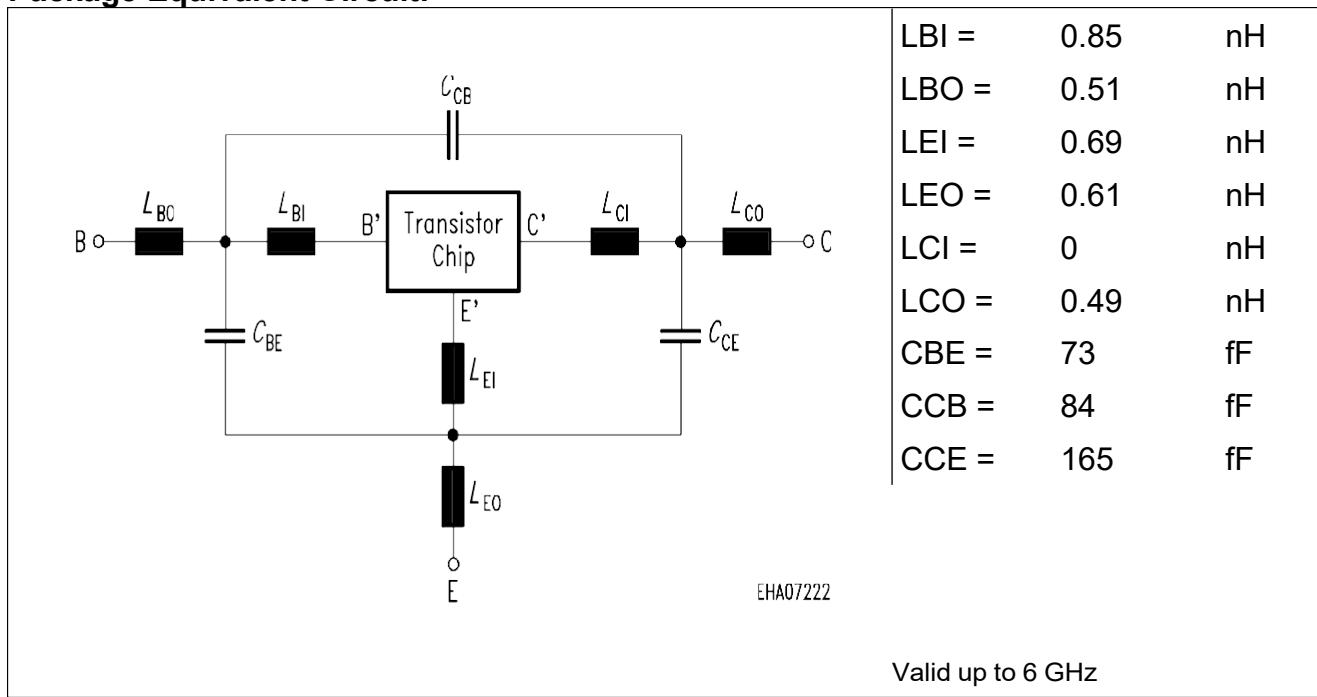
Transition frequency $I_C = 30 \text{ mA}, V_{CE} = 8 \text{ V}, f = 500 \text{ MHz}$	f_T	4	5.5	-	GHz
Collector-base capacitance $V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}$	C_{cb}	-	0.8	1.3	pF
Collector-emitter capacitance $V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}$	C_{ce}	-	0.28	-	
Emitter-base capacitance $V_{EB} = 0.5 \text{ V}, f = 1 \text{ MHz}$	C_{eb}	-	1.6	-	
Noise figure $I_C = 2 \text{ mA}, V_{CE} = 8 \text{ V}, Z_S = Z_{Sopt}$ $f = 900 \text{ MHz}$ $f = 1.8 \text{ GHz}$	F	-	2.7	-	dB
-	-	-	4.6	-	
Power gain ²⁾ $I_C = 30 \text{ mA}, V_{CE} = 8 \text{ V}, Z_S = Z_{Sopt}$ $Z_L = Z_{Lopt}$ $f = 900 \text{ MHz}$ $f = 1.8 \text{ GHz}$	G_{ma}	-	11.5	-	
-	-	-	6.5	-	
Transducer gain $I_C = 30 \text{ mA}, V_{CE} = 8 \text{ V}, Z_S = Z_L = 50 \Omega$ $f = 900 \text{ MHz}$ $f = 1.8 \text{ GHz}$	$ S_{21e} ^2$	-	10	-	
-	-	-	5	-	

$$2) G_{ma} = |S_{21}/S_{12}| (k - (k^2 - 1)^{1/2})$$

SPICE Parameters (Gummel-Poon Model, Berkeley-SPICE 2G.6 Syntax) :**Transistor Chip Data**

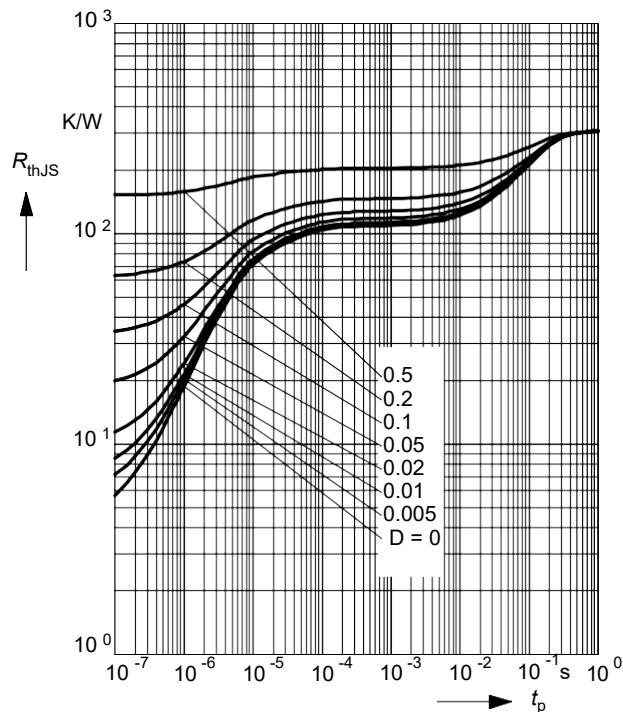
IS =	1.0366	fA	BF =	80	-	NF =	1.0313	-
VAF =	8.4866	V	IKF =	0.47497	A	ISE =	16.295	fA
NE =	1.3702	-	BR =	16.116	-	NR =	1.2907	-
VAR =	9.5149	V	IKR =	0.012081	A	ISC =	0.094971	fA
NC =	1.038	-	RB =	3.2133	Ω	IRB =	0.46855	mA
RBM =	2.0822	Ω	RE =	1.9597	Ω	RC =	1.1393	Ω
CJE =	20.636	fF	VJE =	0.84456	V	MJE =	0.68352	-
TF =	54.303	ps	XTF =	0.27447	-	VTF =	0.19311	V
ITF =	3.0573	mA	PTF =	0	deg	CJC =	2690.4	fF
VJC =	1.0282	V	MJC =	0.5401	-	XCJC =	0.075977	-
TR =	0.34233	ns	CJS =	0	fF	VJS =	0.75	V
MJS =	0	-	XTB =	0	-	EG =	1.11	eV
XTI =	3	-	FC =	0.54298	-	TNOM	300	K

All parameters are ready to use, no scaling is necessary.

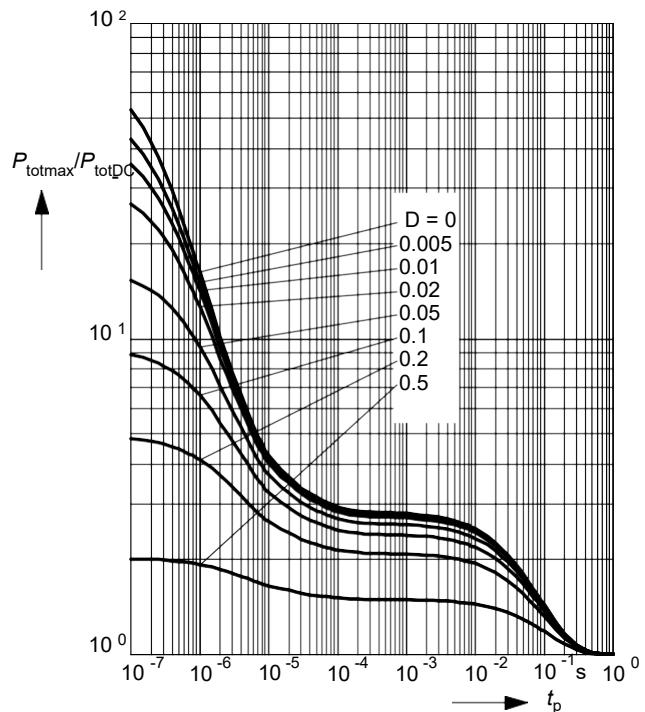
Package Equivalent Circuit:

Valid up to 6 GHz

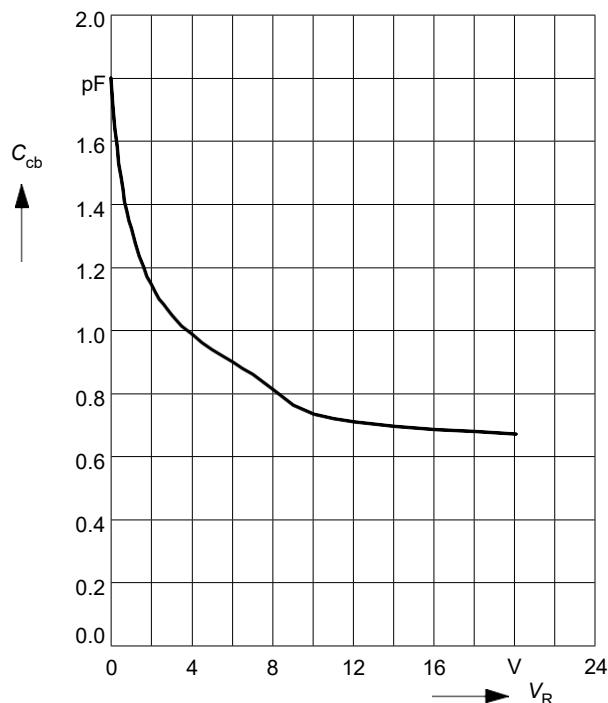
Typical Characteristics



Permissible Pulse Load $R_{thJS} = f(t_p)$

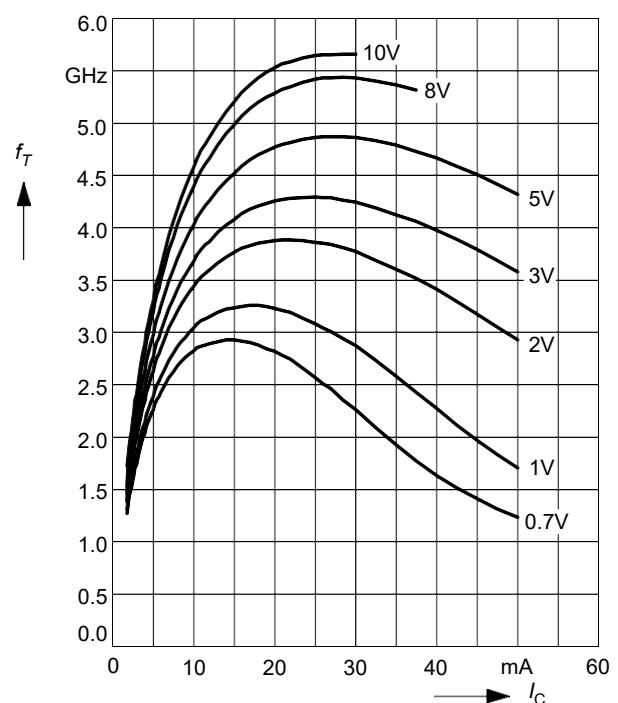


Permissible Pulse Load $P_{totmax}/P_{totDC} = f(t_p)$



Collector-base capacitance $C_{cb} = f(V_{CB})$

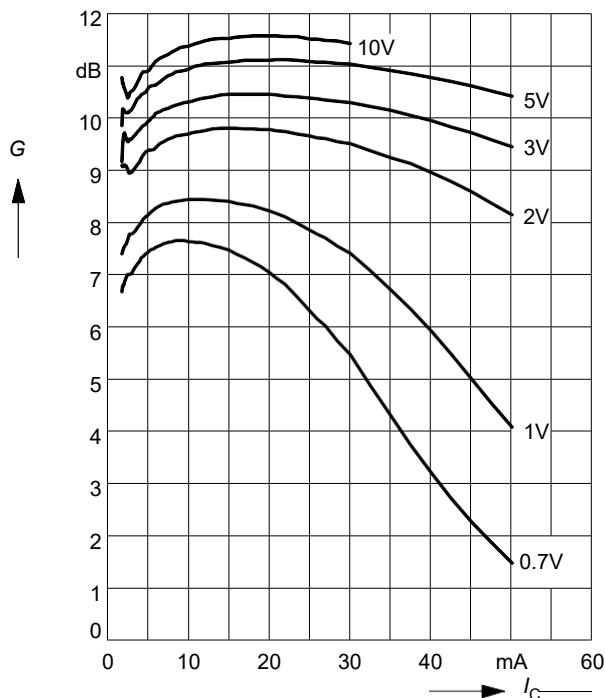
$V_{BE} = V_{be} = 0$, $f = 1\text{MHz}$



Transition frequency $f_T = f(I_C)$

V_{CE} = Parameter

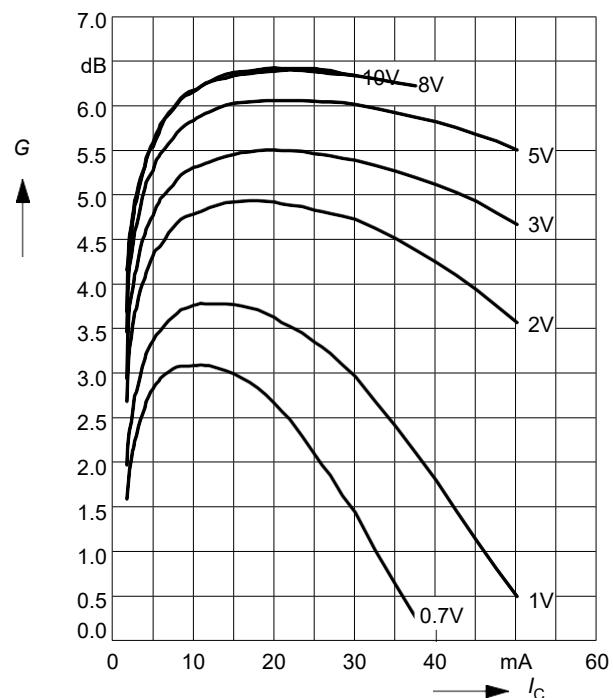
Typical Characteristics



Power Gain G_{ma} , $G_{ms} = f(I_C)$

$f = 0.9\text{GHz}$

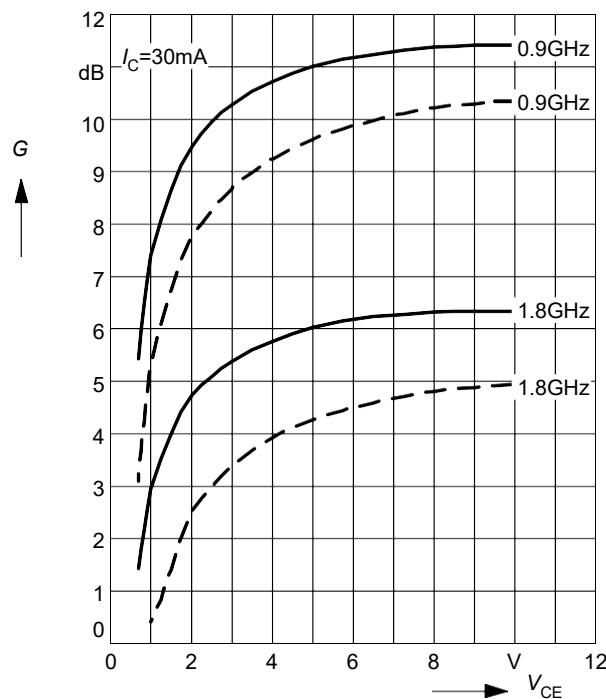
V_{CE} = Parameter



Power Gain G_{ma} , $G_{ms} = f(I_C)$

$f = 1.8\text{GHz}$

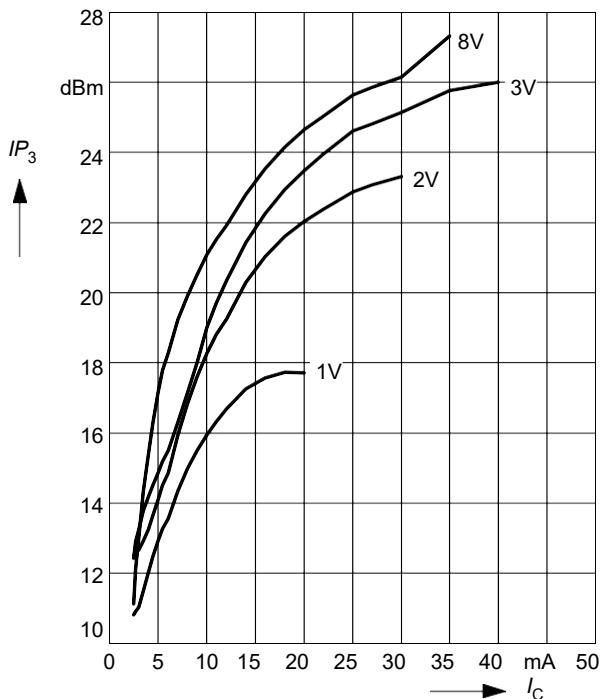
V_{CE} = Parameter



Power Gain G_{ma} , $G_{ms} = f(V_{CE})$: _____

$|S_{21}|^2 = f(V_{CE})$: -----

f = Parameter

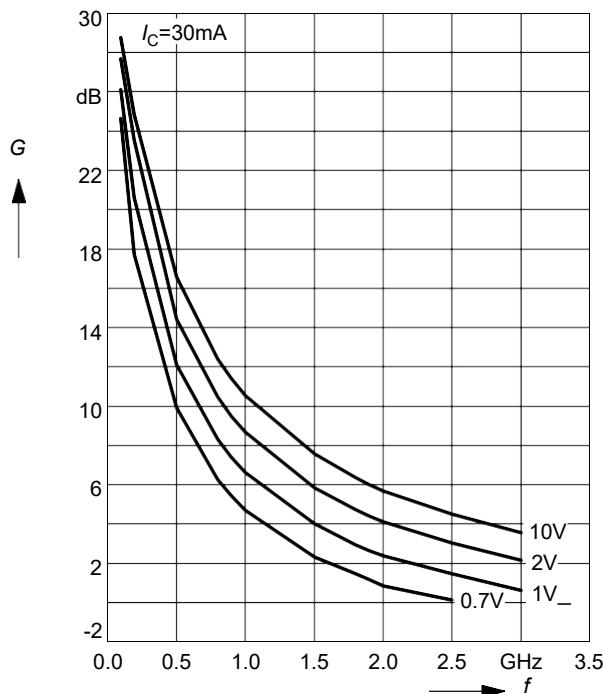


Intermodulation Intercept Point $IP_3=f(I_C)$

(3rd order, Output, $Z_S=Z_L=50\Omega$)

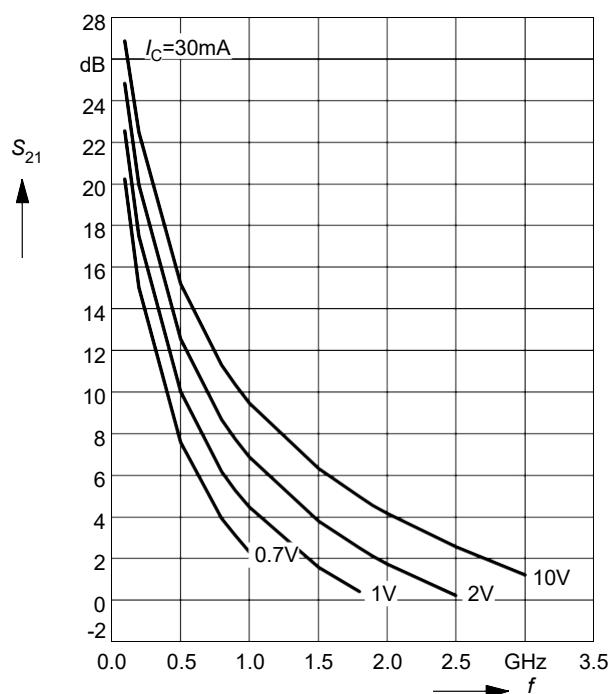
V_{CE} = Parameter, $f = 900\text{MHz}$

Typical Characteristics



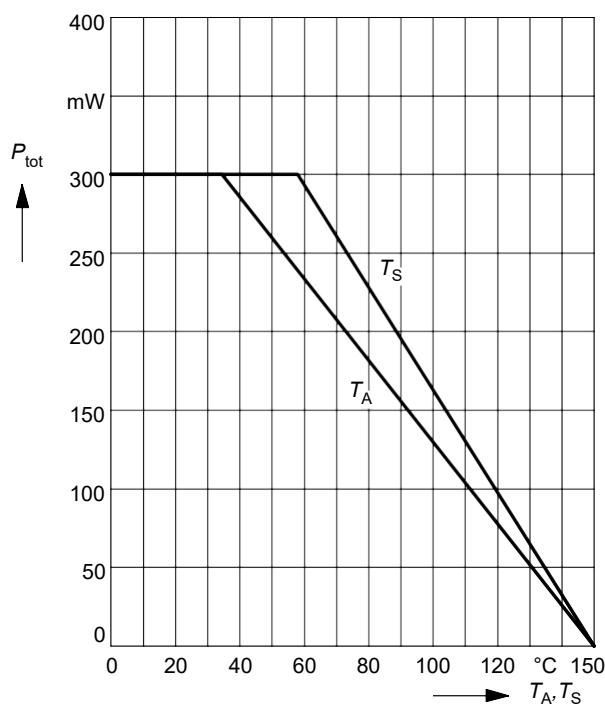
Power Gain $G_{ma}, G_{ms} = f(f)$

V_{CE} = Parameter



Power Gain $|S_{21}|^2 = f(f)$

V_{CE} = Parameter



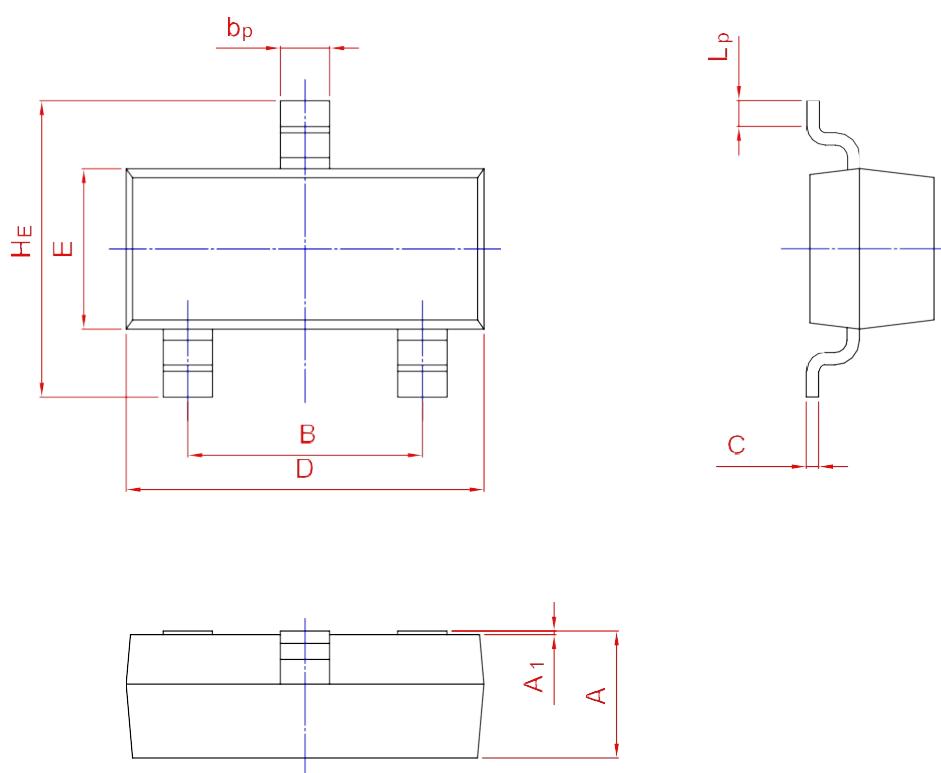
Total power dissipation $P_{tot} = f(T_A^*, T_S)$

* Package mounted on epoxy

PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT-23



UNIT	A	B	b_p	C	D	E	H_E	A_1	L_p
mm	1.40 0.95	2.04 1.78	0.50 0.35	0.19 0.08	3.10 2.70	1.65 1.20	3.00 2.20	0.100 0.013	0.50 0.20